SWITCHMODE Power Rectifier

These state-of-the-art devices are designed for use in negative switching power supplies, inverters and as free wheeling diodes. Also, used in conjunction with common cathode dual Ultrafast Rectifiers, makes a single phase full-wave bridge.

Features

- Common Anode Dual Rectifier (8.0 A per Leg or 16 A per Package)
- Ultrafast 35 Nanosecond Reverse Recovery Times
- Exhibits Soft Recovery Characteristics
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Complement to MUR1620CT and MURB1620CT Common Cathode Device
- ESD Ratings:
 - ♦ Machine Model = C (> 400 V)
 - ◆ Human Body Model = 3B (> 16,000 V)
- AEC-Q101 Qualified and PPAP Capable
- NRVU Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: MUR1620CTR: 1.9 Grams (Approximately)
 MURB1620CTR: 1.7 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



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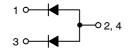
ULTRAFAST RECTIFIER16 AMPERES, 200 VOLTS





TO-220AB CASE 221A STYLE 7

D²PAK CASE 418B STYLE 5



MARKING DIAGRAMS





TO-220AB

D²PAK

U1620R = Device Code KAK = Diode Polarity A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
Average Rectified Forward Voltage (Rated V _R , T _C = 160°C) Per Leg Per Total Device	I _{F(AV)}	8.0 16	A
Peak Repetitive Surge Current (Rated V _R , Square Wave, 20 kHz, T _C = 140°C) Per Diode	I _{FM}	16	А
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	100	А
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +175	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	2.0	°C/W
Thermal Resistance, Junction-to-Ambient (D ² PAK)	$R_{ heta JA}$	45	°C/W

ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 1) ($i_F = 8.0 \text{ Amps}, T_C = 25^{\circ}\text{C}$) ($i_F = 8.0 \text{ Amps}, T_C = 150^{\circ}\text{C}$)	VF	1.2 1.1	V
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_C = 25^{\circ}C$) (Rated dc Voltage, $T_C = 150^{\circ}C$)	İR	5.0 500	μΑ
Maximum Reverse Recovery Time (I _F = 1.0 Amp, di/dt = 50 Amps/μs)	t _{rr}	85	ns

^{1.} Pulse Test: Pulse Width = 5.0 ms, Duty Cycle \leq 10%.

ORDERING INFORMATION

Device	Package	Shipping [†]
MUR1620CTRG	TO-220 (Pb-Free)	50 Units / Rail
MURB1620CTRG	D ² PAK-3 (Pb-Free)	50 Units / Rail
MURB1620CTRT4G	D ² PAK-3 (Pb-Free)	800 / Tape & Reel
NRVUB1620CTRT4G	D ² PAK-3 (Pb-Free)	800 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

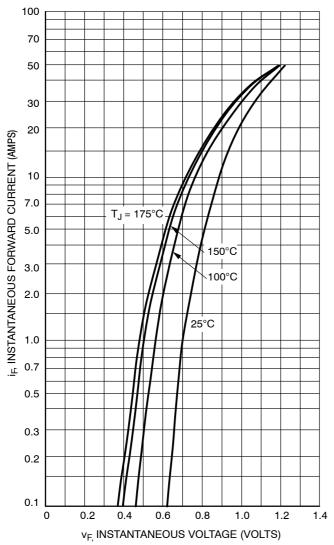


Figure 1. Typical Forward Voltage (Per Leg)

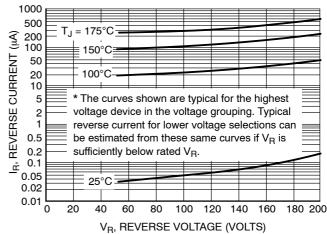


Figure 2. Typical Reverse Current* (Per Leg)

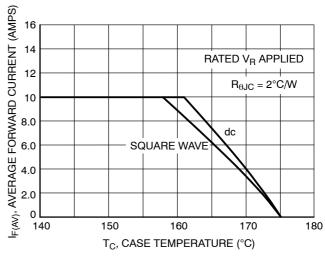
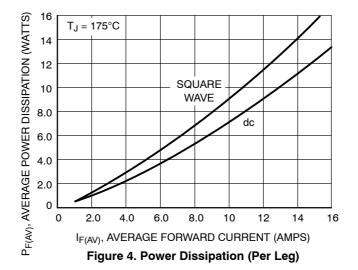


Figure 3. Current Derating, Case (Per Leg)



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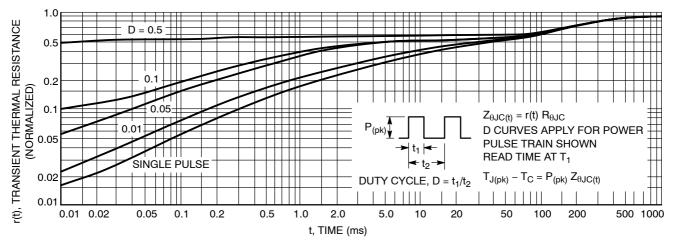


Figure 5. Thermal Response

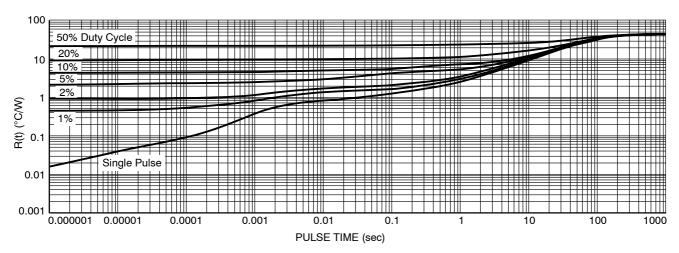


Figure 6. Thermal Response, Junction-to-Ambient

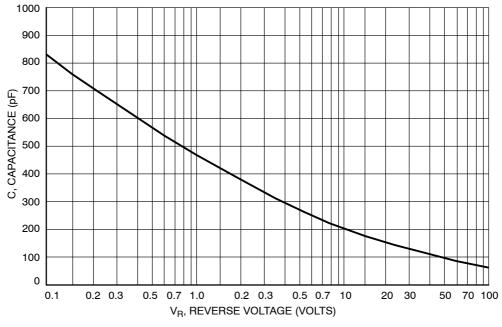
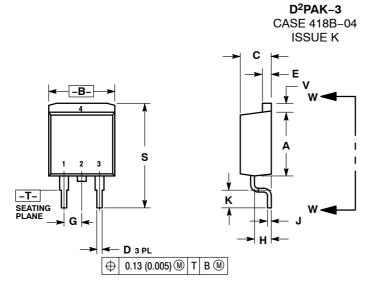


Figure 7. Typical Capacitance (Per Leg)

PACKAGE DIMENSIONS



NOTES:

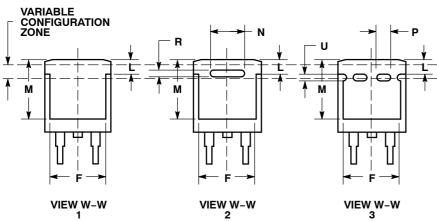
- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

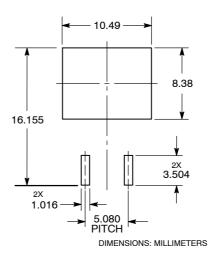
 2. CONTROLLING DIMENSION: INCH. 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.340	0.380	8.64	9.65
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
Н	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
М	0.280	0.320	7.11	8.13
N	0.197	0.197 REF		REF
P	0.079 REF		2.00 REF	
R	0.039	0.039 REF		REF
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

- STYLE 5: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. ANODE



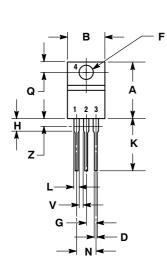
SOLDERING FOOTPRINT*

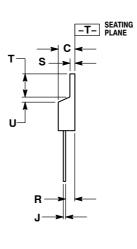


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 ISSUE AG





NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - CONTROLLING DIMENSION: INCH.
- 2. CONTROLLING DIMENSION. INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL
 BODY AND LEAD IRREGULARITIES ARE
 ALLOWED.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.036	0.64	0.91
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

STYLE 7:

PIN 1. CATHODE

- 2. ANODE
- B. CATHODE
- B. CATHOD B. ANODE

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